

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc1744ifw#pbf

(Engineering Calculation)

TSSOP 6.1mm WIDTH

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**TOTAL MASS (g) : 0.178989**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.005644	1000000	31532.671875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.065071	975000	363547.5625		
		Iron (Fe)	7439-89-6	0.001602	24000	8950.27246094		
		Phosphorus (P)	7723-14-0	0.000020	300	111.738731384		
		Zinc (Zn)	7440-66-6	0.000047	700	262.586029053		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.066740</b>	<b>1000000</b>	<b>372872.15625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.004601	1000000	25705.2832031		
		<b>External Plating Total:</b>				<b>0.004601</b>	<b>1000000</b>	<b>25705.2832031</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000600	1000000	3352.16210938		
<b>Internal Plating Total:</b>				<b>0.000600</b>	<b>1000000</b>	<b>3352.16210938</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001410	750000	7877.58105469		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000470	250000	2625.86035156		
<b>Die Attach Total:</b>				<b>0.001880</b>	<b>1000000</b>	<b>10503.4414062</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.015269	155000	85306.9375		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.082748	840000	462307.84375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000493	5000	2754.35986328		
		<b>Encapsulation Total:</b>				<b>0.098510</b>	<b>1000000</b>	<b>550369.125</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.001014	1000000	5665.15429688		
					<b>TOTAL MASS (g) :</b>	<b>0.178989</b>		